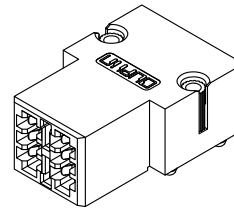


REV.	SPECIFICATION	ECN NO.	APPD.
R2		ECN170709	



Material and Plating:

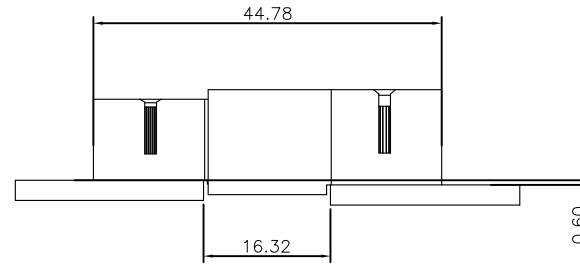
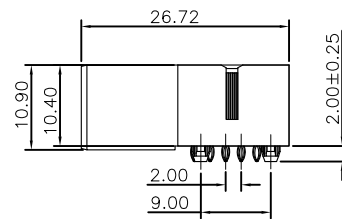
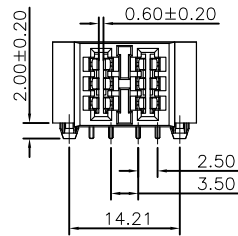
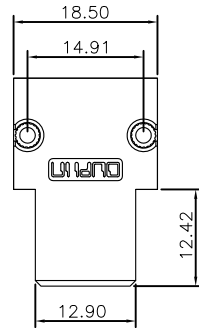
Housing: LCP, UL94V-0, BLACK.
 Power Contacts: High Conductivity Copper,
 30u"Au+Pd/Ni on Contact Area and 80u"Min
 Tin Plated on Solder Tail over nickel 50u"Min.

Electrical Characteristics:

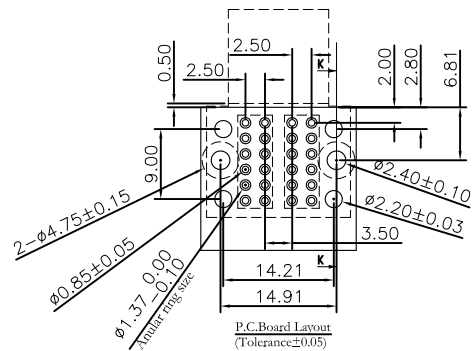
Current Rating: Power Pin 65 AMP.
 Dielectric Withstanding Voltage: AC 1500V For 1 minute.
 Insulator Resistance: 1500MΩ min. at DC 500V.
 Contact Resistance: Power Pin :4.5mΩ Max initial, After testing5mΩ Max.
 Operating Temperature: -40°C ~+85°C .
***RoHS Compliant**

Notes:

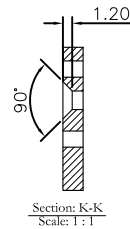
Durability: 200 cycles Max.
 Screw specification:GB819-85_M2X10, Shipment quantity:3PCS.



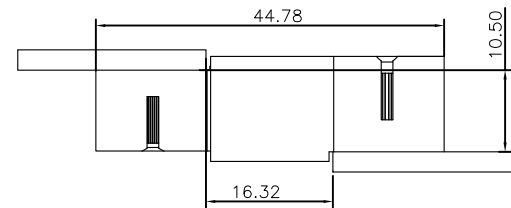
器件正插圖



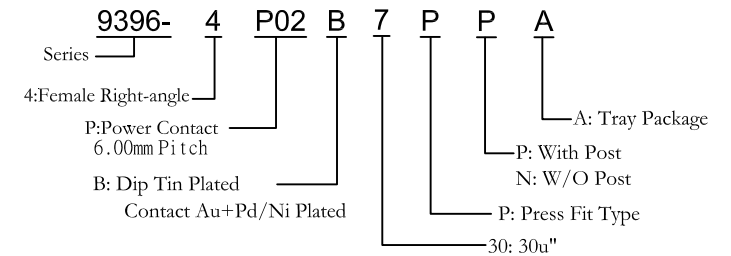
P.C. Board Layout
(Tolerance±0.05)



Section: K-K
Scale: 1:1



器件反插圖



Tolerances	Dwg. No.	9396-D0000-004		Title:		
x = ±0.5	Projection			Daughtercard and Daughtercard power Connector		
.x = ±0.25	Unit	mm	Scale			1:1
.xx = ±0.15	Drawn By	MXM 07/07'2017				

OUPIN ELECTRONIC(KUNSHAN) CO., LTD.			
P/N: 9396-4P02B7PPA			
SHEET	1/1	Ver. No.	R2